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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

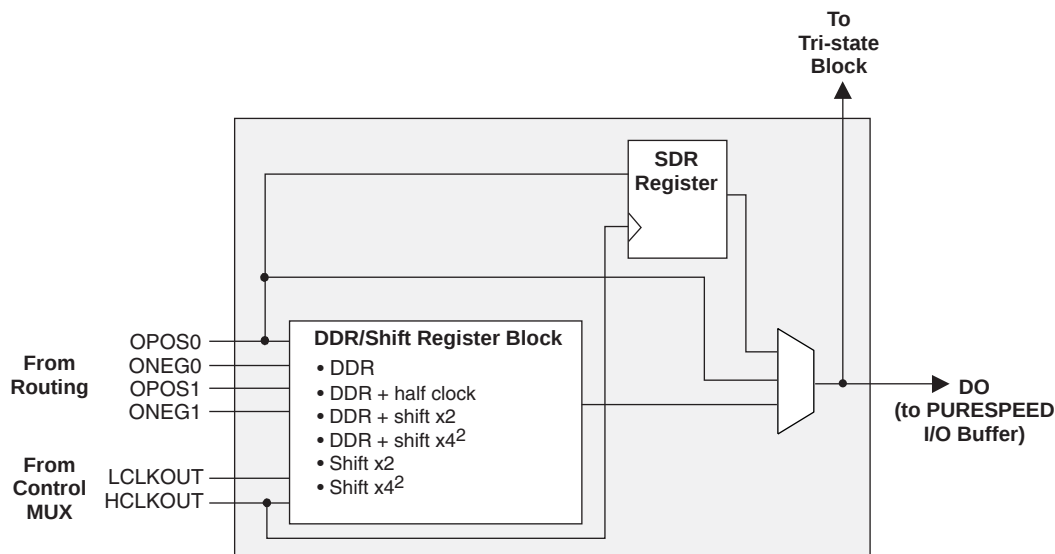
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

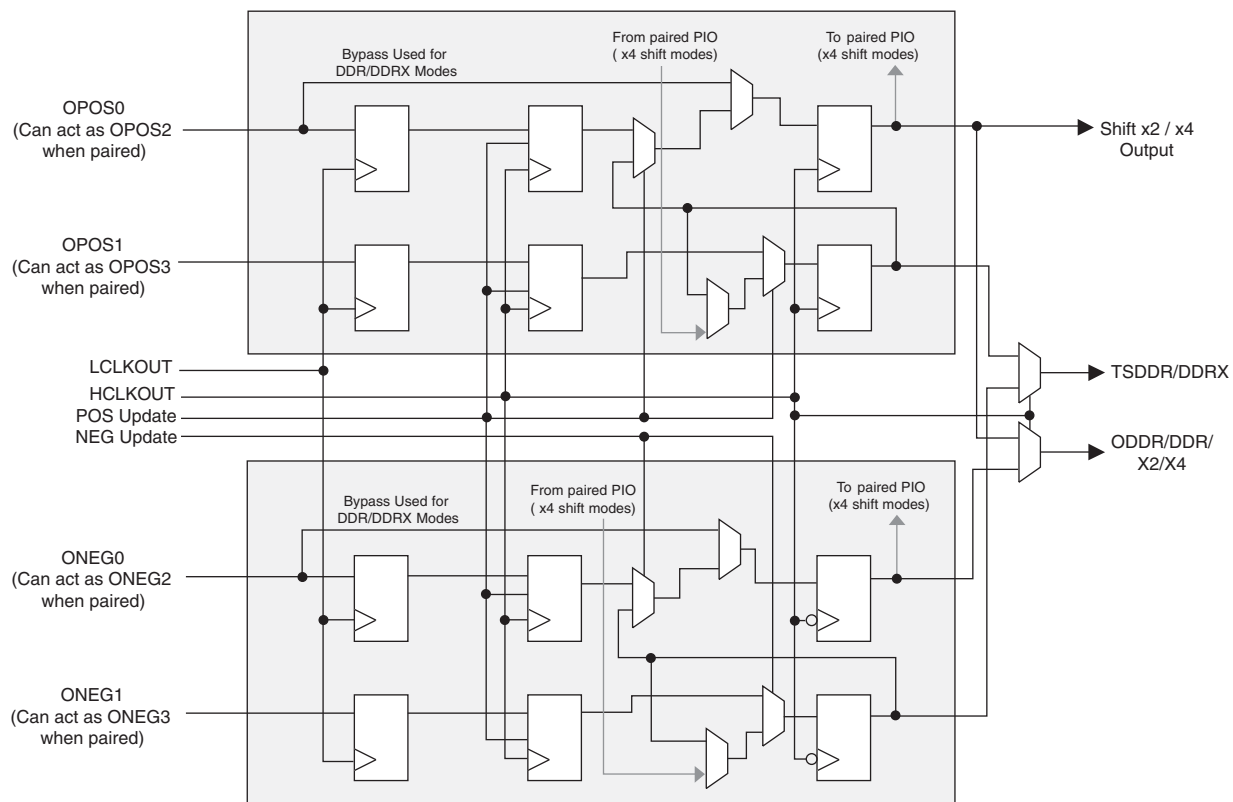
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	604
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga40ep1-6fc1152c

Figure 2-22. Output Register Block¹**Notes:**

1. CE, Update, Set and Reset not shown for clarity.
2. By four shift modes utilizes DDR/Shift register block from paired PIO.
3. DDR/Shift register block shared with tristate block.

Figure 2-23. Output/Tristate DDR/Shift Register Block

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of three registers for DDR and shift register operation. The output signal tri-state control signal (TO) can be derived directly from one of the inputs (bypass mode), the SDR shift register, the DDR registers or the data associated with the buffer (for open drain emulation). Figure 2-24 shows the diagram of the Tristate Register Block.

Tristate SDR Register/Latch Block

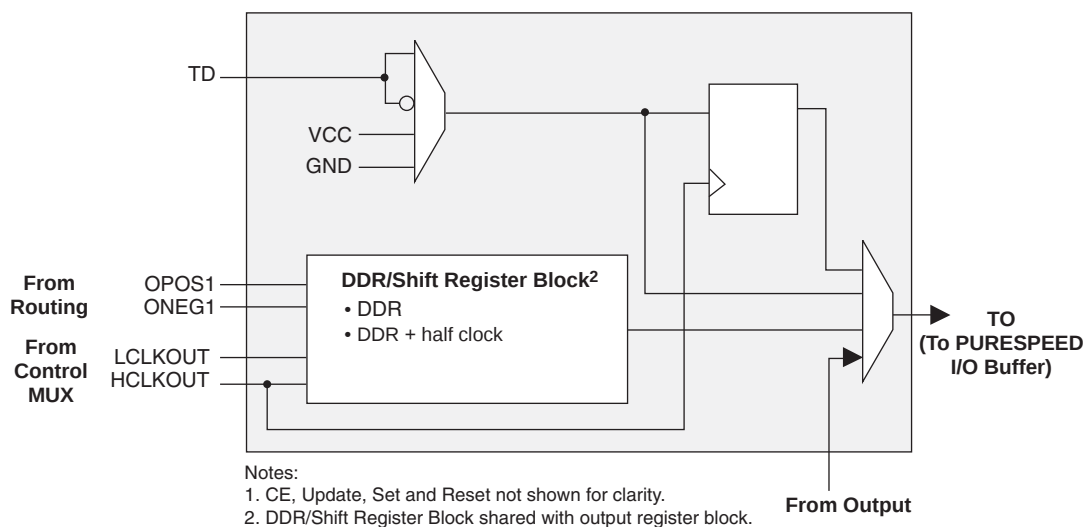
The SDR register operates on the positive edge of the high-speed clock. In it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR input is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Tristate DDR/Shift Register Block

The DDR/Shift block is shared with the output block allowing DDR support using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric to provide a high-speed tri-state control stream.

There is a special mode for DDR-II memory interfaces where the termination is controlled by the output tristate signal. During WRITE cycle when the FPGA is driving the lines, the parallel terminations are turned off. During READ cycle when the FPGA is receiving data, the parallel terminations are turned on.

Figure 2-24. Tristate Register Block¹



I/O Architecture Rules

Table 2-6 shows the PIO usage for x1, x2, x4 gearing. The checkmarks in the columns show the specific PIOs that are used for each gearing mode. When using x2 or x4 gearing, any PIO which is not used for gearing can still be used as an output.

Figure 2-27. Output Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Series termination (controlled output impedance)		
Parallel termination to V_{CCIO} , or parallel driving end		
Parallel termination to $V_{CCIO}/2$ driving end		
Combined series + parallel termination to $V_{CCIO}/2$ at driving end (only series termination moved on-chip)		
Combined series + parallel to $V_{CCIO}/2$ driving end		

Differential Input Termination

The LatticeSC device allows two types of differential termination. The first is a single resistor across the differential inputs. The second is a center-tapped system where each input is terminated to the on-chip termination bus V_{CMT} . The V_{CMT} bus is DC-coupled through an internal capacitor to ground.

Figure 2-29 shows the differential termination schemes and Table 2-9 shows the nominal values of the termination resistors.

Figure 2-29. Differential Termination Scheme

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Differential termination		
Differential and common mode termination		

Calibration

There are two calibration sources that are associated with the termination scheme used in the LatticeSC devices:

- DIFFR – This pin occurs in each bank that supports differential drivers and must be connected through a 1K+/-1% resistor to ground if differential outputs are used. Note that differential drivers are not supported in banks 1, 4 and 5.
- XRES – There is one of these pins per device. It is used for several functions including calibrating on-chip termination. This pin should always be connected through a 1K+/-1% resistor to ground.

The LatticeSC devices support two modes of calibration:

- Continuous – In this mode the SC devices continually calibrate the termination resistances. Calibration happens several times a second. Using this mode ensures that termination resistances remain calibrated as the silicon junction temperature changes.
- User Request – In this mode the calibration circuit operates continuously. However, the termination resistor values are only updated on the assertion of the calibration_update signal available to the core logic.

For more information on calibration, refer to the details of additional technical documentation at the end of this data sheet.

Hot Socketing

The LatticeSC devices have been carefully designed to ensure predictable behavior during power-up and power-down. To ensure proper power sequencing, care must be taken during power-up and power-down as described below. During power-up and power-down sequences, the I/Os remain in tristate until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled to within specified limits,

Internal Logic Analyzer Capability (ispTRACY)

All LatticeSC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time. For additional detail refer to technical information at the end of the data sheet.

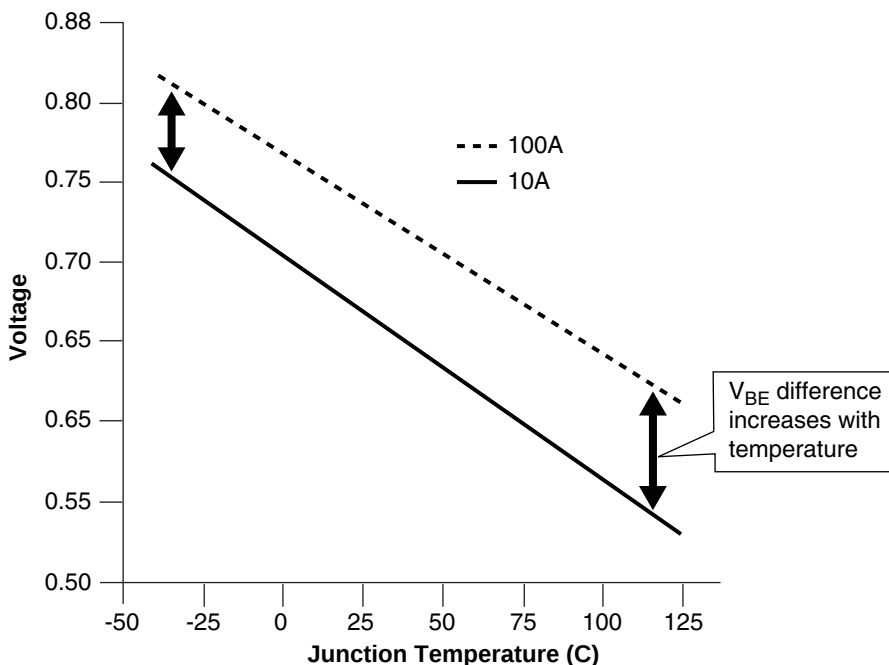
Temperature Sensing

Lattice provides a way to monitor the die temperature by using a temperature-sensing diode that is designed into every LatticeSC device. The difference in V_{BE} of the diode at two different forward currents varies with temperature. This relationship is shown in Figure 2-33. The accuracy of the temperature-sensing diode is typically $\pm 10^{\circ}\text{C}$.

On packages that include PROBE_GND, the most accurate measurements will occur between the TEMP pin and the PROBE_GND pin. On packages that do not include PROBE_GND, measurements should be made between the TEMP pin and board ground.

This temperature-sensing diode is designed to work with an external temperature sensor such as the Maxim 1617A. The Maxim 1617A is configured to measure difference in V_{BE} (of the temperature-sensing diode) at $10\mu\text{A}$ and at $100\mu\text{A}$. This difference in V_{BE} voltage varies with temperature at approximately $1.64\text{ mV}/^{\circ}\text{C}$. A typical device with a 85°C junction temperature will measure approximately 593mV . For additional detail refer to TN1115, [Temperature Sensing Diode in LatticeSC Devices](#).

Figure 2-33. Sensing Diode Typical Characteristics



Oscillator

Every LatticeSC device has an internal CMOS oscillator, which is used as a master serial clock for configuration and is also available as a potential general purpose clock (MCK) for the FPGA core. There is a K divider (divide by 2/4/8/16/32/64/128) available with this oscillator to get lower MCK frequencies. This clock is available as a general purpose clock signal to the software routing tool. For additional detail refer to technical information at the end of the data sheet.

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

MLVDS

The LatticeSC devices support the MLVDS standard. This industry standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. MLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-1 is one possible solution for bi-directional multi-point differential signals.

Figure 3-1. MLVDS Multi-Point Output Example

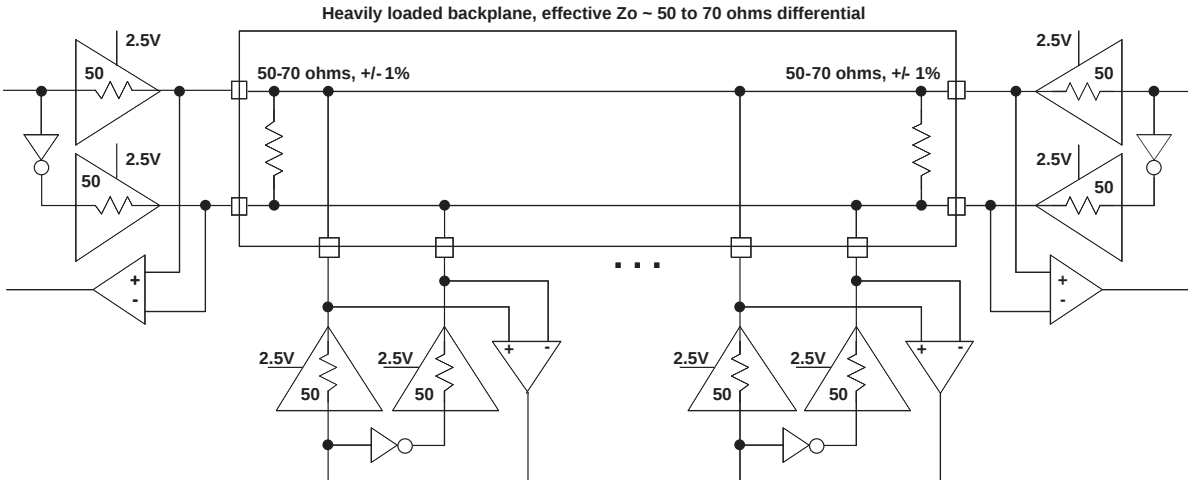


Table 3-1. MLVDS DC Conditions¹

Over Recommended Operating Conditions

Symbol	Description	Nominal		Units
		$Z_o = 50$	$Z_o = 70$	
Z_{OUT}	Output impedance	50	50	ohm
R_{TLEFT}	Left end termination	50	70	ohm
R_{TRIGHT}	Right end termination	50	70	ohm
V_{OH}	Output high voltage	1.50	1.575	V
V_{OL}	Output low voltage	1.00	0.925	V
V_{OD}	Output differential voltage	0.50	0.65	V
V_{CM}	Output common mode voltage	1.25	1.25	V
I_{DC}	DC output current	20.0	18.5	mA

1. For input buffer, see LVDS table.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
MPI_STRBN	I	Driven active low indicates the start of a transaction on the PowerPC bus. MPI will strobe the address bus at next rising edge of clock.
MPI_ADDR[31:14]	I	Address bus driven by a PowerPC bus master. Only 18-bit width is needed. It has to be the least significant bit of the PowerPC 32-bit address A[31:14].
MPI_DAT[n:0]	I/O	Selectable data bus width from 8, and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
MPI_PAR[m:0]	I/O	Selectable parity bus width from 1, 2, and 3-bit. MPI_DP[0] for MPI_D[7:0], MPI_DP[1] for MPI_D[15:8] and MPI_DP[2] for MPI_D[23:16].
MPI_TA	O	Transfer acknowledge. Driven active low indicates that MPI received the data on the write cycle or returned data on the read cycle.
MPI_TEA	O	Transfer Error Acknowledge. Driven active low indicates that MPI detects a bus error on the internal system bus for current transaction.
MPI_RETRY	O	Active low MPI Retry requests the MPC860 to relinquish the bus and retry the cycle.
Multi-chip Alignment (User I/O if not used.)		
MCA_DONE_OUT	O	Multi-chip alignment done output (to second MCA chip)
MCA_DONE_IN	I	Multi-chip alignment done input (from second MCA chip)
MCA_CLK_P[1:2]_OUT	O	Multi-chip alignment clock [1:2] output (sourced by MCA master chip)
MCA_CLK_P[1:2]_IN	I	Multi-chip alignment clock [1:2] input (from MCA master chip)
TEMP	—	Temperature sensing diode pin. Dedicated pin. Accuracy is typically +/- 10°C.
Miscellaneous Dedicated Pins		
XRES	—	External reference resistor between this pin and ground. The reference resistor is used to calibrate the programmable terminating resistors used in the I/Os. Dedicated pin. Value: 1K ± 1% ohm.
DIFFRx	—	Only used if a differential driver is used in a bank. This DIFFRx must be connected to ground via an external 1K ±1% ohm resistor for all banks that have a differential driver.
SERDES Block (Dedicated Pins)		
[A:D]_HDINPx_[L/R]	I	High-speed input (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDINNx_[L/R]	I	High-speed input (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTPx_[L/R]	O	High-speed output (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTNx_[L/R]	O	High-speed output (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_REFCLKP_[L/R]	I	Ref clock input (positive), aux channel on left [L] or right [R] side of device.
[A:D]_REFCLKN_[L/R]	I	Ref clock input (negative), aux channel on left [L] or right [R] side of device.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D14	PT15B	1	A15/MPI_ADDR29	PT25B	1	A15/MPI_ADDR29
D13	PT15A	1	A17/MPI_ADDR31	PT25A	1	A17/MPI_ADDR31
F12	PT13D	1	A19/MPI_TSI21	PT24D	1	A19/MPI_TSI21
F13	PT13C	1	A20/MPI_BDIP	PT24C	1	A20/MPI_BDIP
B12	PT11B	1	A18/MPI_TSI20	PT24B	1	A18/MPI_TSI20
B11	PT11A	1	MPI_TEA	PT24A	1	MPI_TEA
E12	PT10D	1	D14/MPI_DATA14	PT23D	1	D14/MPI_DATA14
D12	PT10C	1	DP1/MPI_PAR1	PT23C	1	DP1/MPI_PAR1
G10	PT9B	1	A21/MPI_BURST	PT23B	1	A21/MPI_BURST
G9	PT9A	1	D15/MPI_DATA15	PT23A	1	D15/MPI_DATA15
C10	A_VDDIB3_L	-		A_VDDIB3_L	-	
E9	VCC12	-		VCC12	-	
B10	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A10	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
D9	VCC12	-		VCC12	-	
A9	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C9	A_VDDOB3_L	-		A_VDDOB3_L	-	
A8	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C8	A_VDDOB2_L	-		A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E8	VCC12	-		VCC12	-	
B8	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
B7	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
C7	A_VDDIB2_L	-		A_VDDIB2_L	-	
D8	VCC12	-		VCC12	-	
C6	A_VDDIB1_L	-		A_VDDIB1_L	-	
E7	VCC12	-		VCC12	-	
B6	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A6	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
D7	VCC12	-		VCC12	-	
A5	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C5	A_VDDOB1_L	-		A_VDDOB1_L	-	
A4	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C4	A_VDDOB0_L	-		A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E6	VCC12	-		VCC12	-	
B4	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
B3	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
C3	A_VDDIB0_L	-		A_VDDIB0_L	-	
D6	VCC12	-		VCC12	-	
L5	NC	-		PL21A	7	
M5	NC	-		PL21B	7	
G2	NC	-		PL20A	7	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E16	PT45C	1	D3/MPI_DATA3	PT54C	1	D3/MPI_DATA3
C13	PT45B	1	D2/MPI_DATA2	PT53B	1	D2/MPI_DATA2
C14	PT45A	1	D1/MPI_DATA1	PT53A	1	D1/MPI_DATA1
B14	PT43B	1	D0/MPI_DATA0	PT51B	1	D0/MPI_DATA0
B13	PT43A	1	QOUT/CEON	PT51A	1	QOUT/CEON
L13	PT42D	1	VREF2_1	PT50D	1	VREF2_1
C15	PT42B	1	DOUT	PT50B	1	DOUT
D15	PT42A	1	MCA_DONE_IN	PT50A	1	MCA_DONE_IN
J16	PT41B	1	MCA_CLK_P1_OUT	PT49B	1	MCA_CLK_P1_OUT
K16	PT41A	1	MCA_CLK_P1_IN	PT49A	1	MCA_CLK_P1_IN
H15	PT39D	1	D21/PCLKC1_1/MPI_DATA21	PT47D	1	D21/PCLKC1_1/MPI_DATA21
H16	PT39C	1	D22/PCLKT1_1/MPI_DATA22	PT47C	1	D22/PCLKT1_1/MPI_DATA22
A14	PT39B	1	MCA_CLK_P2_OUT	PT47B	1	MCA_CLK_P2_OUT
A13	PT39A	1	MCA_CLK_P2_IN	PT47A	1	MCA_CLK_P2_IN
G16	PT38D	1	MCA_DONE_OUT	PT46D	1	MCA_DONE_OUT
F16	PT38C	1	BUSYN/RCLK/SCK	PT46C	1	BUSYN/RCLK/SCK
B16	PT38B	1	DP0/MPI_PAR0	PT46B	1	DP0/MPI_PAR0
B15	PT38A	1	MPI_TA	PT46A	1	MPI_TA
L16	PT37C	1	DP2/MPI_PAR2	PT45C	1	DP2/MPI_PAR2
A16	PT37B	1	PCLKC1_0	PT45B	1	PCLKC1_0
A15	PT37A	1	PCLKT1_0/MPI_CLK	PT45A	1	PCLKT1_0/MPI_CLK
L17	PT35C	1	D24/PCLKT1_4/MPI_DATA24	PT43C	1	D24/PCLKT1_4/MPI_DATA24
A17	PT35B	1	MPI_RETRY	PT43B	1	MPI_RETRY
A18	PT35A	1	A0/MPI_ADDR14	PT43A	1	A0/MPI_ADDR14
F17	PT33D	1	A1/MPI_ADDR15	PT42D	1	A1/MPI_ADDR15
G17	PT33C	1	A2/MPI_ADDR16	PT42C	1	A2/MPI_ADDR16
B17	PT33B	1	A3/MPI_ADDR17	PT42B	1	A3/MPI_ADDR17
B18	PT33A	1	A4/MPI_ADDR18	PT42A	1	A4/MPI_ADDR18
H17	PT32D	1	D25/PCLKC1_5/MPI_DATA25	PT41D	1	D25/PCLKC1_5/MPI_DATA25
H18	PT32C	1	D26/PCLKT1_5/MPI_DATA26	PT41C	1	D26/PCLKT1_5/MPI_DATA26
A19	PT32B	1	A5/MPI_ADDR19	PT41B	1	A5/MPI_ADDR19
A20	PT32A	1	A6/MPI_ADDR20	PT41A	1	A6/MPI_ADDR20
L20	PT31C	1	VREF1_1	PT39C	1	VREF1_1
J17	PT31B	1	A7/MPI_ADDR21	PT39B	1	A7/MPI_ADDR21
K17	PT31A	1	A8/MPI_ADDR22	PT39A	1	A8/MPI_ADDR22
C18	PT29B	1	A9/MPI_ADDR23	PT38B	1	A9/MPI_ADDR23
D18	PT29A	1	A10/MPI_ADDR24	PT38A	1	A10/MPI_ADDR24
B19	PT28B	1	A11/MPI_ADDR25	PT37B	1	A11/MPI_ADDR25
B20	PT28A	1	A12/MPI_ADDR26	PT37A	1	A12/MPI_ADDR26
E17	PT27D	1	D11/MPI_DATA11	PT35D	1	D11/MPI_DATA11
E18	PT27C	1	D12/MPI_DATA12	PT35C	1	D12/MPI_DATA12
C20	PT27B	1	A13/MPI_ADDR27	PT35B	1	A13/MPI_ADDR27
C19	PT27A	1	A14/MPI_ADDR28	PT35A	1	A14/MPI_ADDR28
H19	PT25D	1	A16/MPI_ADDR30	PT33D	1	A16/MPI_ADDR30
G19	PT25C	1	D13/MPI_DATA13	PT33C	1	D13/MPI_DATA13
D20	PT25B	1	A15/MPI_ADDR29	PT33B	1	A15/MPI_ADDR29
D19	PT25A	1	A17/MPI_ADDR31	PT33A	1	A17/MPI_ADDR31
H20	PT24D	1	A19/MPI_TSI21	PT30D	1	A19/MPI_TSI21
G20	PT24C	1	A20/MPI_BDIP	PT30C	1	A20/MPI_BDIP
E19	PT24B	1	A18/MPI_TSI20	PT30B	1	A18/MPI_TSI20

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F19	PT24A	1	MPI_TEA	PT30A	1	MPI_TEA
J18	PT23D	1	D14/MPI_DATA14	PT28D	1	D14/MPI_DATA14
K18	PT23C	1	DP1/MPI_PAR1	PT28C	1	DP1/MPI_PAR1
E20	PT23B	1	A21/MPI_BURST	PT27B	1	A21/MPI_BURST
F20	PT23A	1	D15/MPI_DATA15	PT27A	1	D15/MPI_DATA15
C23	B_REFCLKP_L	-		B_REFCLKP_L	-	
D23	B_REFCLKN_L	-		B_REFCLKN_L	-	
B23	VCC12	-		VCC12	-	
H21	B_VDDIB3_L	-		B_VDDIB3_L	-	
F21	B_HDINP3_L	-	PCS 361 CH 3 IN P	B_HDINP3_L	-	PCS 361 CH 3 IN P
G21	B_HDINN3_L	-	PCS 361 CH 3 IN N	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D21	B_VDDOB3_L	-		B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D22	B_VDDOB2_L	-		B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
G22	B_HDINN2_L	-	PCS 361 CH 2 IN N	B_HDINN2_L	-	PCS 361 CH 2 IN N
F22	B_HDINP2_L	-	PCS 361 CH 2 IN P	B_HDINP2_L	-	PCS 361 CH 2 IN P
H22	B_VDDIB2_L	-		B_VDDIB2_L	-	
H24	B_VDDIB1_L	-		B_VDDIB1_L	-	
G23	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
H23	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A24	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
B24	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B25	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A25	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
G25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
F25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
H25	B_VDDIB0_L	-		B_VDDIB0_L	-	
H26	A_VDDIB3_L	-		A_VDDIB3_L	-	
F26	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
G26	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
D26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
D27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
G27	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
F27	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
H27	A_VDDIB2_L	-		A_VDDIB2_L	-	
F29	A_VDDIB1_L	-		A_VDDIB1_L	-	
G28	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
H28	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A29	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B29	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
D29	A_VDDOB1_L	-		A_VDDOB1_L	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AA7	VCCIO3	-		VCCIO3	-	
AB9	VCCIO3	-		VCCIO3	-	
AC4	VCCIO3	-		VCCIO3	-	
AD6	VCCIO3	-		VCCIO3	-	
AF3	VCCIO3	-		VCCIO3	-	
T3	VCCIO3	-		VCCIO3	-	
U4	VCCIO3	-		VCCIO3	-	
V6	VCCIO3	-		VCCIO3	-	
W10	VCCIO3	-		VCCIO3	-	
Y3	VCCIO3	-		VCCIO3	-	
AC11	VCCIO4	-		VCCIO4	-	
AD14	VCCIO4	-		VCCIO4	-	
AF15	VCCIO4	-		VCCIO4	-	
AF9	VCCIO4	-		VCCIO4	-	
AG12	VCCIO4	-		VCCIO4	-	
AJ13	VCCIO4	-		VCCIO4	-	
AJ7	VCCIO4	-		VCCIO4	-	
AK10	VCCIO4	-		VCCIO4	-	
AK16	VCCIO4	-		VCCIO4	-	
AK4	VCCIO4	-		VCCIO4	-	
AC19	VCCIO5	-		VCCIO5	-	
AD22	VCCIO5	-		VCCIO5	-	
AF21	VCCIO5	-		VCCIO5	-	
AG18	VCCIO5	-		VCCIO5	-	
AG24	VCCIO5	-		VCCIO5	-	
AJ17	VCCIO5	-		VCCIO5	-	
AJ23	VCCIO5	-		VCCIO5	-	
AJ30	VCCIO5	-		VCCIO5	-	
AK20	VCCIO5	-		VCCIO5	-	
AK26	VCCIO5	-		VCCIO5	-	
AA27	VCCIO6	-		VCCIO6	-	
AB23	VCCIO6	-		VCCIO6	-	
AC30	VCCIO6	-		VCCIO6	-	
AD26	VCCIO6	-		VCCIO6	-	
AF29	VCCIO6	-		VCCIO6	-	
T29	VCCIO6	-		VCCIO6	-	
U30	VCCIO6	-		VCCIO6	-	
V26	VCCIO6	-		VCCIO6	-	
W24	VCCIO6	-		VCCIO6	-	
Y29	VCCIO6	-		VCCIO6	-	
G30	VCCIO7	-		VCCIO7	-	
J27	VCCIO7	-		VCCIO7	-	
K29	VCCIO7	-		VCCIO7	-	
L24	VCCIO7	-		VCCIO7	-	
M26	VCCIO7	-		VCCIO7	-	
N30	VCCIO7	-		VCCIO7	-	
P23	VCCIO7	-		VCCIO7	-	
R27	VCCIO7	-		VCCIO7	-	
AA11	VCCAUX	-		VCCAUX	-	
AA12	VCCAUX	-		VCCAUX	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF21	PB26D	5		PB29D	5	
AN23	PB27A	5		PB45A	5	
AN22	PB27B	5		PB45B	5	
AP23	PB29A	5		PB55A	5	
AP22	PB29B	5		PB55B	5	
AG21	PB29C	5		PB55C	5	
AG20	PB29D	5		PB55D	5	
AP25	PB30A	5	PCLKT5_3	PB48A	5	PCLKT5_3
AP24	PB30B	5	PCLKC5_3	PB48B	5	PCLKC5_3
AD21	PB30C	5	PCLKT5_4	PB48C	5	PCLKT5_4
AD20	PB30D	5	PCLKC5_4	PB48D	5	PCLKC5_4
AL23	PB31A	5	PCLKT5_5	PB49A	5	PCLKT5_5
AL22	PB31B	5	PCLKC5_5	PB49B	5	PCLKC5_5
AH24	PB31C	5		PB49C	5	
AH23	PB31D	5		PB49D	5	
AM23	PB33A	5	PCLKT5_0	PB51A	5	PCLKT5_0
AM22	PB33B	5	PCLKC5_0	PB51B	5	PCLKC5_0
AJ24	PB33C	5		PB51C	5	
AJ23	PB33D	5	VREF2_5	PB51D	5	VREF2_5
AN21	PB34A	5	PCLKT5_1	PB52A	5	PCLKT5_1
AN20	PB34B	5	PCLKC5_1	PB52B	5	PCLKC5_1
AE19	PB34C	5	PCLKT5_6	PB52C	5	PCLKT5_6
AD19	PB34D	5	PCLKC5_6	PB52D	5	PCLKC5_6
AK21	PB35A	5	PCLKT5_2	PB53A	5	PCLKT5_2
AK20	PB35B	5	PCLKC5_2	PB53B	5	PCLKC5_2
AK23	PB35C	5	PCLKT5_7	PB53C	5	PCLKT5_7
AK22	PB35D	5	PCLKC5_7	PB53D	5	PCLKC5_7
AL20	PB37A	5		PB56A	5	
AL19	PB37B	5		PB56B	5	
AG19	PB37C	5		PB56C	5	
AF19	PB37D	5		PB56D	5	
AP21	PB38A	5		PB57A	5	
AP20	PB38B	5		PB57B	5	
AH21	PB38C	5		PB57C	5	
AH20	PB38D	5		PB57D	5	
AM20	PB39A	5		PB59A	5	
AM19	PB39B	5		PB59B	5	
AJ21	PB39C	5		PB59C	5	
AJ20	PB39D	5		PB59D	5	
AK19	PB41A	5		PB60A	5	
AK18	PB41B	5		PB60B	5	
AE18	PB41C	5		PB60C	5	
AD18	PB41D	5		PB60D	5	
AN19	PB42A	5		PB61A	5	
AN18	PB42B	5		PB61B	5	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AG18	PB42C	5		PB61C	5	
AF18	PB42D	5		PB61D	5	
AP19	PB43A	5		PB63A	5	
AP18	PB43B	5		PB63B	5	
AJ18	PB43C	5		PB63C	5	
AH18	PB43D	5		PB63D	5	
AP17	PB45A	4		PB65A	4	
AP16	PB45B	4		PB65B	4	
AJ17	PB45C	4		PB65C	4	
AH17	PB45D	4		PB65D	4	
AN17	PB46A	4		PB66A	4	
AN16	PB46B	4		PB66B	4	
AE17	PB46C	4		PB66C	4	
AD17	PB46D	4		PB66D	4	
AK17	PB47A	4		PB67A	4	
AK16	PB47B	4		PB67B	4	
AG17	PB47C	4		PB67C	4	
AF17	PB47D	4		PB67D	4	
AM16	PB49A	4		PB69A	4	
AM15	PB49B	4		PB69B	4	
AJ15	PB49C	4		PB69C	4	
AJ14	PB49D	4		PB69D	4	
AL16	PB50A	4		PB70A	4	
AL15	PB50B	4		PB70B	4	
AG16	PB50C	4		PB70C	4	
AF16	PB50D	4		PB70D	4	
AP15	PB51A	4		PB71A	4	
AP14	PB51B	4		PB71B	4	
AH15	PB51C	4		PB71C	4	
AH14	PB51D	4		PB71D	4	
AN15	PB53A	4	PCLKT4_2	PB74A	4	PCLKT4_2
AN14	PB53B	4	PCLKC4_2	PB74B	4	PCLKC4_2
AE16	PB53C	4	PCLKT4_7	PB74C	4	PCLKT4_7
AD16	PB53D	4	PCLKC4_7	PB74D	4	PCLKC4_7
AK15	PB54A	4	PCLKT4_1	PB75A	4	PCLKT4_1
AK14	PB54B	4	PCLKC4_1	PB75B	4	PCLKC4_1
AG15	PB54C	4	PCLKT4_6	PB75C	4	PCLKT4_6
AG14	PB54D	4	PCLKC4_6	PB75D	4	PCLKC4_6
AM13	PB55A	4	PCLKT4_0	PB77A	4	PCLKT4_0
AM12	PB55B	4	PCLKC4_0	PB77B	4	PCLKC4_0
AJ12	PB55C	4	VREF2_4	PB77C	4	VREF2_4
AJ11	PB55D	4		PB77D	4	
AL13	PB57A	4	PCLKT4_5	PB79A	4	PCLKT4_5
AL12	PB57B	4	PCLKC4_5	PB79B	4	PCLKC4_5
AH12	PB57C	4		PB79C	4	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
C2	VCCJ	-		VCCJ	-	
M9	TDO	-	TDO	TDO	-	TDO
L9	TMS	-		TMS	-	
D1	TCK	-		TCK	-	
C1	TDI	-		TDI	-	
J8	PROGRAMN	1		PROGRAMN	1	
K8	MPIIRQN	1	CFGIRQN/MPI_IRQ_N	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
B2	CCLK	1		CCLK	1	
H9	RESP_URC	-		RESP_URC	-	
H10	VCC12	-		VCC12	-	
H8	A_REFCLKN_R	-		A_REFCLKN_R	-	
G8	A_REFCLKP_R	-		A_REFCLKP_R	-	
C3	VCC12	-		VCC12	-	
D3	A_VDDIB0_R	-		A_VDDIB0_R	-	
A3	A_HDINP0_R	-	PCS 3E0 CH 0 IN P	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
B3	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
E5	VCC12	-		VCC12	-	
A4	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
F6	A_VDDOB0_R	-		A_VDDOB0_R	-	
B4	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
F7	A_VDDOB1_R	-		A_VDDOB1_R	-	
B5	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
E6	VCC12	-		VCC12	-	
A5	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
B6	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
A6	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
C6	VCC12	-		VCC12	-	
D4	A_VDDIB1_R	-		A_VDDIB1_R	-	
C7	VCC12	-		VCC12	-	
D5	A_VDDIB2_R	-		A_VDDIB2_R	-	
A7	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
B7	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
E7	VCC12	-		VCC12	-	
A8	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
F8	A_VDDOB2_R	-		A_VDDOB2_R	-	
B8	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
F9	A_VDDOB3_R	-		A_VDDOB3_R	-	
B9	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
E8	VCC12	-		VCC12	-	
A9	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
B10	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
A10	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
C10	VCC12	-		VCC12	-	
D6	A_VDDIB3_R	-		A_VDDIB3_R	-	
G10	VCC12	-		VCC12	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
V8	PR65D	3	PCLKC3_3
U8	PR65C	3	PCLKT3_3
U5	PR65B	3	
T5	PR65A	3	
V6	PR64D	3	PCLKC3_1
U6	PR64C	3	PCLKT3_1
T4	PR64B	3	PCLKC3_0
T3	PR64A	3	PCLKT3_0
U9	PR62D	2	PCLKC2_2
T9	PR62C	2	PCLKT2_2
R2	PR62B	2	PCLKC2_0
P2	PR62A	2	PCLKT2_0
T11	PR61D	2	PCLKC2_3
U11	PR61C	2	PCLKT2_3
R4	PR61B	2	PCLKC2_1
R3	PR61A	2	PCLKT2_1
T8	PR60D	2	
R8	PR60C	2	
P1	PR60B	2	
N1	PR60A	2	
R6	PR57D	2	
P6	PR57C	2	
M1	PR57B	2	
L1	PR57A	2	
T10	PR56D	2	
U10	PR56C	2	
N2	PR56B	2	
M2	PR56A	2	
R11	PR51D	2	
P11	PR51C	2	
N4	PR51B	2	
M4	PR51A	2	
N5	PR49D	2	
M5	PR49C	2	
L2	PR49B	2	
K2	PR49A	2	
P8	PR47D	2	
N8	PR47C	2	
J2	PR47B	2	
H2	PR47A	2	
M6	PR45D	2	
L6	PR45C	2	
K3	PR45B	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
K26	GND	-	
K28	GND	-	
K6	GND	-	
K9	GND	-	
L12	GND	-	
L32	GND	-	
L4	GND	-	
M10	GND	-	
M17	GND	-	
M24	GND	-	
N29	GND	-	
N7	GND	-	
P15	GND	-	
P20	GND	-	
P3	GND	-	
P31	GND	-	
R10	GND	-	
R14	GND	-	
R16	GND	-	
R19	GND	-	
R21	GND	-	
R26	GND	-	
T15	GND	-	
T17	GND	-	
T18	GND	-	
T20	GND	-	
T28	GND	-	
T6	GND	-	
U16	GND	-	
U19	GND	-	
U23	GND	-	
U32	GND	-	
U4	GND	-	
V12	GND	-	
V16	GND	-	
V19	GND	-	
V3	GND	-	
V31	GND	-	
W15	GND	-	
W17	GND	-	
W18	GND	-	
W20	GND	-	
W29	GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P38	PL26B	7		PL40B	7	
N35	PL26C	7		PL40C	7	
N36	PL26D	7		PL40D	7	
N39	PL29A	7		PL43A	7	
P39	PL29B	7		PL43B	7	
R34	PL29C	7	VREF1_7	PL43C	7	VREF1_7
T34	PL29D	7	DIFFR_7	PL43D	7	DIFFR_7
L41	PL30A	7		PL44A	7	
M41	PL30B	7		PL44B	7	
W29	PL30C	7		PL44C	7	
Y29	PL30D	7		PL44D	7	
L42	PL31A	7		PL45A	7	
M42	PL31B	7		PL45B	7	
U32	PL31C	7		PL45C	7	
V32	PL31D	7		PL45D	7	
R37	PL33A	7		PL47A	7	
T37	PL33B	7		PL47B	7	
M36	PL33C	7		PL47C	7	
M37	PL33D	7		PL47D	7	
P40	PL34A	7		PL48A	7	
N40	PL34B	7		PL48B	7	
R35	PL34C	7		PL48C	7	
T35	PL34D	7		PL48D	7	
N41	PL35A	7		PL49A	7	
P41	PL35B	7		PL49B	7	
V33	PL35C	7		PL49C	7	
U33	PL35D	7		PL49D	7	
R38	PL37A	7		PL51A	7	
T38	PL37B	7		PL51B	7	
R36	PL37C	7		PL51C	7	
T36	PL37D	7		PL51D	7	
N42	PL38A	7		PL52A	7	
P42	PL38B	7		PL52B	7	
Y31	PL38C	7		PL52C	7	
AA31	PL38D	7		PL52D	7	
U37	PL39A	7		PL53A	7	
V37	PL39B	7		PL53B	7	
U34	PL39C	7		PL53C	7	
V34	PL39D	7		PL53D	7	
U39	PL41A	7		PL55A	7	
T39	PL41B	7		PL55B	7	
V35	PL41C	7		PL55C	7	
W35	PL41D	7		PL55D	7	
R41	PL42A	7		PL56A	7	
T41	PL42B	7		PL56B	7	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AL23	PB56D	5		PB58D	5	
AW24	PB57A	5		PB61A	5	
AW23	PB57B	5		PB61B	5	
AN23	PB57C	5		PB61C	5	
AP23	PB57D	5		PB61D	5	
AY23	PB59A	5		PB63A	5	
AY24	PB59B	5		PB63B	5	
AU23	PB59C	5		PB63C	5	
AU22	PB59D	5		PB63D	5	
AV23	PB60A	5		PB66A	5	
AV22	PB60B	5		PB66B	5	
AM22	PB60C	5		PB66C	5	
AL22	PB60D	5		PB66D	5	
BA23	PB61A	5		PB69A	5	
BA22	PB61B	5		PB69B	5	
AN22	PB61C	5		PB69C	5	
AP22	PB61D	5		PB69D	5	
BB23	PB63A	5		PB71A	5	
BB22	PB63B	5		PB71B	5	
AT22	PB63C	5		PB71C	5	
AR22	PB63D	5		PB71D	5	
BB21	PB65A	4		PB73A	4	
BB20	PB65B	4		PB73B	4	
AR21	PB65C	4		PB73C	4	
AT21	PB65D	4		PB73D	4	
BA21	PB66A	4		PB75A	4	
BA20	PB66B	4		PB75B	4	
AP21	PB66C	4		PB75C	4	
AN21	PB66D	4		PB75D	4	
AV21	PB67A	4		PB78A	4	
AV20	PB67B	4		PB78B	4	
AM21	PB67C	4		PB78C	4	
AL21	PB67D	4		PB78D	4	
AY20	PB69A	4		PB81A	4	
AY19	PB69B	4		PB81B	4	
AU21	PB69C	4		PB81C	4	
AU20	PB69D	4		PB81D	4	
AW20	PB70A	4		PB83A	4	
AW19	PB70B	4		PB83B	4	
AP20	PB70C	4		PB83C	4	
AN20	PB70D	4		PB83D	4	
BB19	PB71A	4		PB86A	4	
BB18	PB71B	4		PB86B	4	
AM20	PB71C	4		PB86C	4	
AL20	PB71D	4		PB86D	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E37	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
D37	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
F34	B_VDDIB0_L	-		B_VDDIB0_L	-	
N29	VCC12	-		VCC12	-	
L30	A_VDDIB3_L	-		A_VDDIB3_L	-	
K31	VCC12	-		VCC12	-	
D38	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
E38	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A37	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
G37	VCC12	-		VCC12	-	
B37	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
L33	A_VDDOB3_L	-		A_VDDOB3_L	-	
B38	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
D41	A_VDDOB2_L	-		A_VDDOB2_L	-	
A38	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
K34	VCC12	-		VCC12	-	
E39	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
D39	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
M32	A_VDDIB2_L	-		A_VDDIB2_L	-	
J32	VCC12	-		VCC12	-	
E41	A_VDDIB1_L	-		A_VDDIB1_L	-	
M33	VCC12	-		VCC12	-	
D40	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
E40	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
B39	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B41	VCC12	-		VCC12	-	
A39	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C41	A_VDDOB1_L	-		A_VDDOB1_L	-	
B40	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
E42	A_VDDOB0_L	-		A_VDDOB0_L	-	
A40	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
F42	VCC12	-		VCC12	-	
D42	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
C42	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
H39	A_VDDIB0_L	-		A_VDDIB0_L	-	
F41	VCC12	-		VCC12	-	
P16	VDDAX25_R	-		VDDAX25_R	-	
P27	VDDAX25_L	-		VDDAX25_L	-	
K39	NC	-		PL32A	7	
L39	NC	-		PL32B	7	
M38	NC	-		PL35A	7	
K40	NC	-		PL36A	7	
L40	NC	-		PL36B	7	
N37	NC	-		PL39A	7	
P37	NC	-		PL39B	7	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSC3GA115E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).